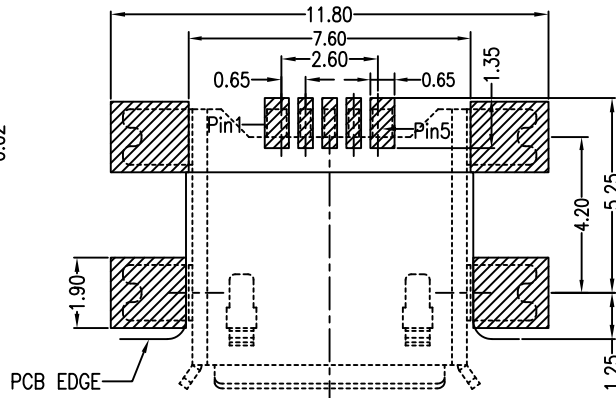
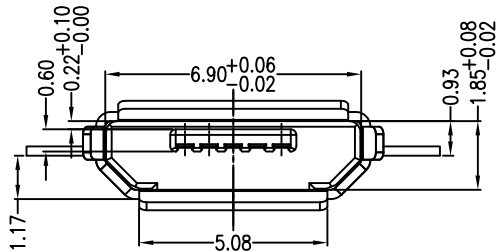
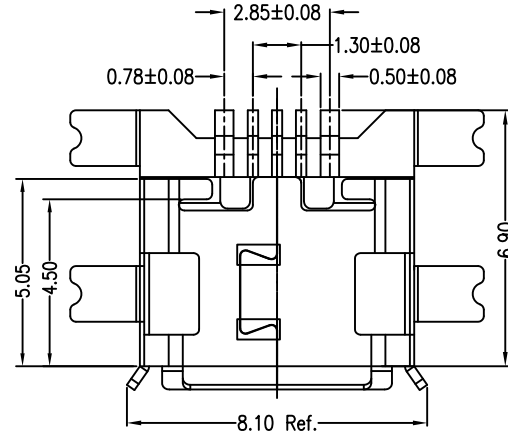
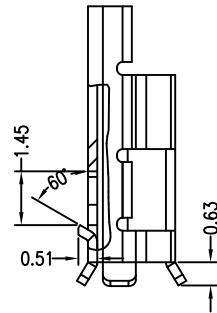
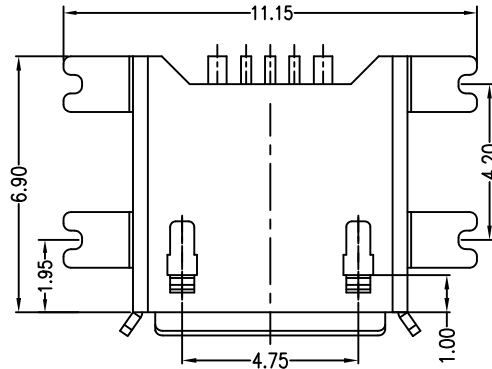
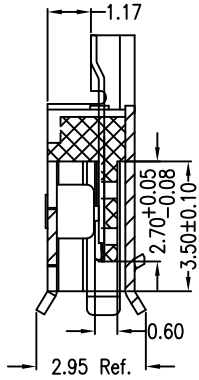
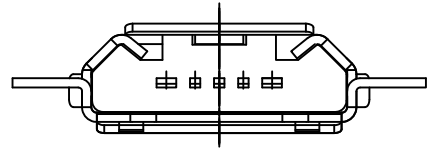


MAPX	MODIFICATION	DATE
------	--------------	------



RECOMMENDED PCB LAYOUT
PCB图仅供参考

- Note:
- Material:
 - Housing: High temperature thermoplastic with g.f,UL94v-0
 - Contact: copper alloy,t=0.15mm
 - Shell: copper alloy,t=0.25mm
 - Specification:
 - Current rating: 3A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 30 mΩ Max.
 - Insulation resistance: 100 MΩ Min.
 - Total mating force: 3.57 Kg Max.
 - Total unmating force: 1.0 Kg Min.
 - Temperature range: -30°C~80°C

产品图
PRODUCT CHART DWG



公差一览表 TOLERANCE UNLESS OTHERWISE		单位 UNITS	MM	制图 DRAWING	制图料号 PRODUCT PART NO	B920-ECF52A2021S10200
X.	±0.30	X.	±5.°	比例 SCALE	产品名称 PRODUCT NAME	MICRO USB 5S B型沉板1.17有边短端 SMT 3A
.X	±0.25	.X	±2.°	日期 DATE	角法 VIEW	版本 VER
.XX	±0.15	.XX	±1.°	2021-04-16	核淮 APPD	AD
.XXX	±0.10	.XXX	±0.5°			